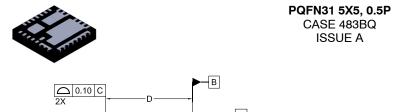


PIN#1

ę.

(E9) 8

**INDICATOR** 



16 15

TOP VIEW

SCALE: 1:1

-(D8)

SEE

DETAIL 'A'

0.10 C

// 0.10 C

○ 0.08 C

(A3)-

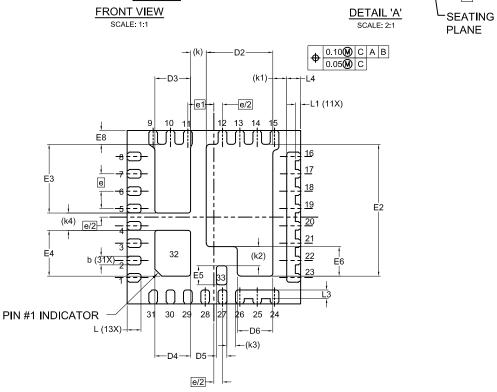
**DATE 06 SEP 2022** 

NOTES: UNLESS OTHERWISE SPECIFIED

- A) DOES NOT FULLY CONFORM TO JEDEC REGISTRATION MO-220, DATED MAY/2005.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

A2

A1<sup>-†</sup>



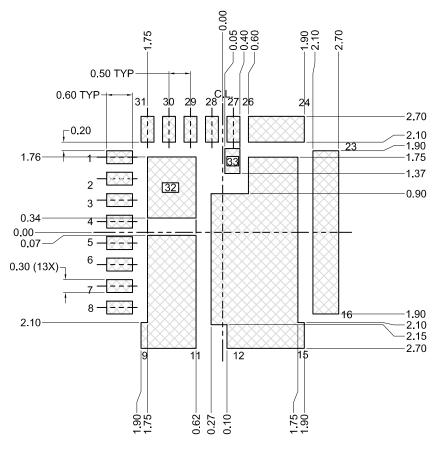
DIM	MILLIMETERS			
DIIVI	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	
A1	0.00	-	0.05	
A2	0.00	-	0.05	
А3	0.20 REF			
b	0.20	0.25	0.30	
D	4.90	5.00	5.10	
D2	1.82	1.92	2.02	
D3	0.93	1.03	1.13	
D4	0.93	1.03	1.13	
D5	0.20	0.30	0.40	
D6	0.93	1.03	1.13	
D7	1.53	1.63	1.73	
D8	0.82 REF			
Е	4.90	5.00	5.10	
E2	3.70	3.80	3.90	
E3	1.88	1.98	2.08	
E4	1.22	1.32	1.42	
E5	0.45	0.55	0.65	
E6	0.75	0.85	0.95	
E7	3.43	3.53	3.63	
E8	0.30	0.40	0.50	
E9	0.68 REF			
е	0.50 BSC			
e/2	0.25 BSC			
e1	0.75 BSC			
k	0.45 REF			
k1	0.40 REF			
k2	0.55 BSC			
k3	0.25 BSC			
k4	0.50 BSC			
L	0.30	0.40	0.50	
L1	0.05	0.15	0.25	
L3	0.15	0.25	0.35	
L4	0.30	0.40	0.50	

BOTTOM VIEW

SCALE: 2:1

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## LAND PATTERN RECOMMENDATION

\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

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